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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the application of:

Gu-Sung KIM

Examiner: Long Pham

Serial No.: 10/073,173

Group Art Unit: 2814

Filed: February 13, 2002

Confirmation No. 4677

For: WAFER LEVEL PACKAGE
WITH AIR PADS AND
MANUFACTURING METHOD
THEREOF

Attorney Docket No. 259/014

REQUEST FOR RECONSIDERATION UNDER 37 C.F.R. § 1.111

Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, Va. 22313-1450

Sir:

In response to the Office action mailed October 19, 2004, the following amendments and remarks are respectfully submitted in connection with the above-identified application:

AMENDMENTS TO THE CLAIMS are reflected in the listing of claims which begins on page 2 of this paper.

REMARKS begin on page 5 of this paper.